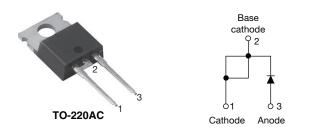
Vishay Semiconductors

High Performance Schottky Rectifier, 10 A



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SHA

PRIMARY CHARACTERISTICS									
I _{F(AV)}	10 A								
V _R	35 V, 40 V, 45 V								
V _F at I _F	0.49 V								
I _{RM}	15 mA at 125 °C								
T _J max.	175 °C								
E _{AS}	13 mJ								
Package	TO-220AC								
Circuit configuration	Single								

FEATURES

- 175 °C T_J operation
- Low forward voltage drop
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance



COMPLIANT

- epoxy HALOGEN Chanical **FREE**
- Guard ring for enhanced ruggedness and long term reliability
- Meet JESD 201 class 2 whisker test
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

The VS-10TQ... Schottky rectifier series has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 175 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS									
SYMBOL	CHARACTERISTICS	VALUES	UNITS						
I _{F(AV)}	Rectangular waveform	10	А						
V _{RRM}		35/45	V						
IFSM	$t_p = 5 \ \mu s \ sine$	1050	А						
V _F	10 A _{pk} , T _J = 125 °C	0.49	V						
TJ	Range	-55 to +175	°C						

VOLTAGE RATINGS										
PARAMETER	SYMBOL	VS-10TQ035HN3	VS-10TQ040HN3	VS-10TQ045HN3	UNITS					
Maximum DC reverse voltage	V _R	35	40	45	V					
Maximum working peak reverse voltage	33	40	45	v						

ABSOLUTE MAXIMUM RATINGS										
PARAMETER	SYMBOL	TEST COND	VALUES	UNITS						
Maximum average forward current See fig. 5	I _{F(AV)}	50 % duty cycle at $T_C = 151 \text{ °C}$	10							
Maximum peak one cycle non-repetitive	-	5 µs sine or 3 µs rect. pulse	Following any rated load	1050	А					
surge current See fig. 7	I _{FSM}	10 ms sine or 6 ms rect. pulse	condition and with rated V _{RRM} applied	280						
Non-repetitive avalanche energy	E _{AS}	$T_J = 25 \text{ °C}, I_{AS} = 2 \text{ A}, L = 6.5 \text{ mH}$	13	mJ						
Repetitive avalanche current	I _{AR}	Current decaying linearly to zero Frequency limited by T _J maximu	2	А						

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 For technical questions within your region: DiodesAsia@vishay.com, DiodesEurope@vishay.com

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ELECTRICAL SPECIFICATIONS									
PARAMETER	SYMBOL	TEST C	VALUES	UNITS					
Maximum forward voltage drop See fig. 1		10 A	T _{.1} = 25 °C	0.57					
	V _{FM} ⁽¹⁾	20 A	1j=25 0	0.67	v				
	VFM (*)	10 A	T.I = 125 °C	0.49					
		20 A	1j = 123 0	0.61					
Maximum reverse leakage current	I _{RM} ⁽¹⁾	T _J = 25 °C	$V_{\rm B}$ = Rated $V_{\rm B}$	2	mA				
See fig. 2	IRM \''	T _J = 125 °C	V _R = naleu V _R	15	IIIA				
Maximum junction capacitance	CT	$V_R = 5 V_{DC}$ (test signal ra	900	pF					
Typical series inductance	Ls	Measured lead to lead	5 mm from package body	8.0	nH				
Maximum voltage rate of change	dV/dt	Rated V _R		10 000	V/µs				

Note

 $^{(1)}\,$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS									
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum junction and storage temperature range		T _J , T _{Stg}		-55 to +175	°C				
Maximum thermal resistance, junction to case		R _{thJC}	DC operation See fig. 4	2.0	°C/W				
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.50	0/10				
Approximate weight				2	g				
Approximate weight				0.07	oz.				
Mounting torque	minimum			6 (5)	kgf. cm				
Mounting torque maximum				12 (10)	(lbf. in)				
Marking device				10TQ	035H				
			Case style TO-220AC	10TQ	040H				
				10TQ	045H				



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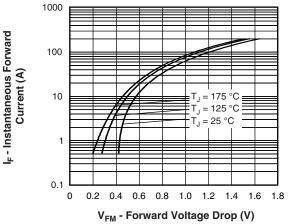


Fig. 1 - Maximum Forward Voltage Drop Characteristics

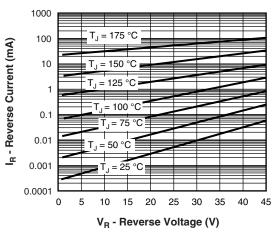


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

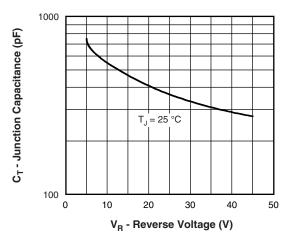


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

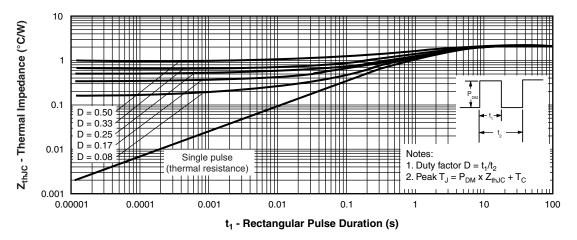
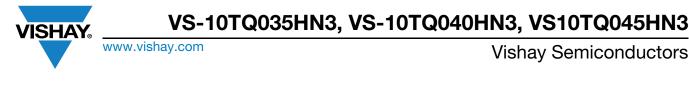


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics

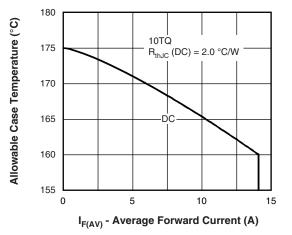
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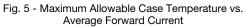
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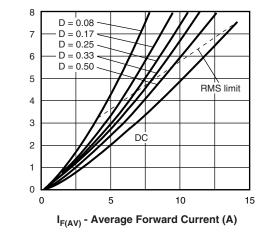
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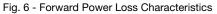


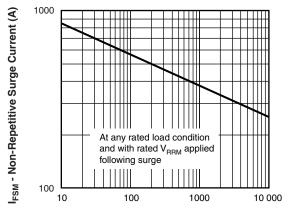
Average Power Loss (W)











t_p - Square Wave Pulse Duration (μs)

Fig. 7 - Maximum Non-Repetitive Surge Current

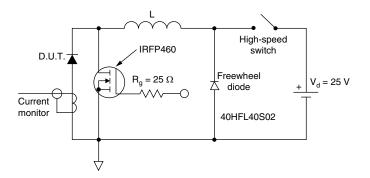


Fig. 8 - Unclamped Inductive Test Circuit



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ORDERING INFORMATION TABLE

Device code	VS-	10	Т	Q	045	Н	N3
		2	3	4	5	6	7
	1 2 3 4 5 6 7 7	Cur Pac T = Sch Volt H = Env	rent rati kage: TO-220 ottky "C age rati AEC-Q ironmer	≀" series ngs — 101 qua ntal digit	Ilfied		035 = 35 040 = 40 045 = 45 liant, an

ORDERING INFORMATION (Example)										
PREFERRED P/N QUANTITY PER T/R MINIMUM ORDER QUANTITY PACKAGING DESCRIPT										
VS-10TQ035HN3	50	1000	Antistatic plastic tube							
VS-10TQ040HN3	50	1000	Antistatic plastic tube							
VS-10TQ045HN3	50	1000	Antistatic plastic tube							

LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?95221
Part marking information	www.vishay.com/doc?95068



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TO-220AC

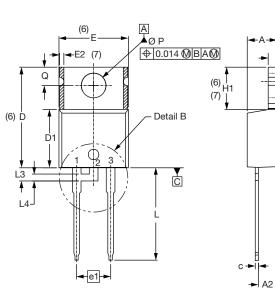
B Seating

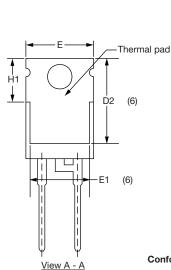
A-

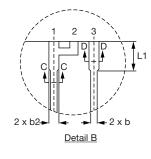
-A1

plane

DIMENSIONS in millimeters and inches









Conforms to JEDEC[®] outline TO-220AC

⊕ 0.015 BA

SYMBOL	MILLIMETERS		INCHES		NOTES	NOTES		MILLIN	IETERS	INC	HES	NOTES
STIVIDUL	MIN.	MAX.	MIN.	MAX.	NOTES		SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.25	4.65	0.167	0.183			E1	6.86	8.89	0.270	0.350	6
A1	1.14	1.40	0.045	0.055			E2	-	0.76	-	0.030	7
A2	2.56	2.92	0.101	0.115			e1	4.88	5.28	0.192	0.208	
b	0.69	1.01	0.027	0.040			H1	5.84	6.86	0.230	0.270	6, 7
b1	0.38	0.97	0.015	0.038	4		L	13.52	14.02	0.532	0.552	
b2	1.20	1.73	0.047	0.068			L1	3.32	3.82	0.131	0.150	2
b3	1.14	1.73	0.045	0.068	4		L3	1.78	2.13	0.070	0.084	
с	0.36	0.61	0.014	0.024			L4	0.76	1.27	0.030	0.050	2
c1	0.36	0.56	0.014	0.022	4		ØΡ	3.54	3.73	0.139	0.147	
D	14.85	15.25	0.585	0.600	3		Q	2.60	3.00	0.102	0.118	
D1	8.38	9.02	0.330	0.355								
D2	11.68	12.88	0.460	0.507	6							
E	10.11	10.51	0.398	0.414	3, 6							

Notes

⁽¹⁾ Dimensioning and tolerancing as per ASME Y14.5M-1994

⁽²⁾ Lead dimension and finish uncontrolled in L1

(3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

- (4) Dimension b1, b3 and c1 apply to base metal only
- ⁽⁵⁾ Controlling dimension: inches
- ⁽⁶⁾ Thermal pad contour optional within dimensions E, H1, D2 and E1

⁽⁷⁾ Dimension E2 x H1 define a zone where stamping and singulation irregularities are allowed

⁽⁸⁾ Outline conforms to JEDEC TO-220, D2 (minimum) where dimensions are derived from the actual package outline

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